



# 11<sup>th</sup> France China Particle Physics Laboratory workshop



## Status of CEPC Calorimeter R&D

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**On Behalf of CEPC Calorimeter Working Group**

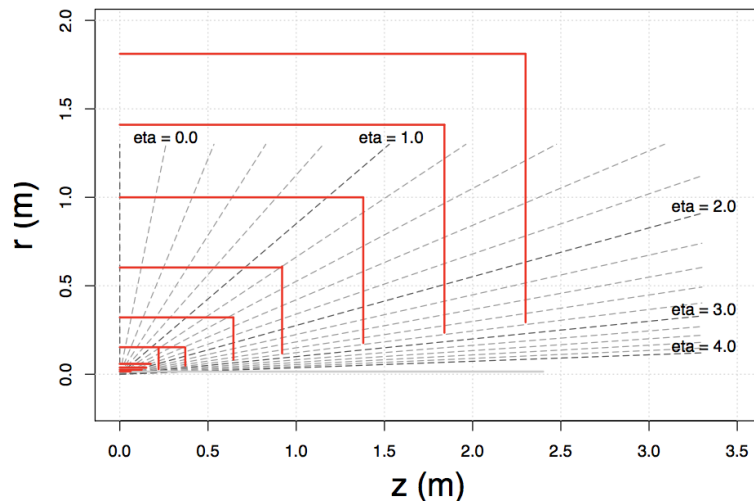
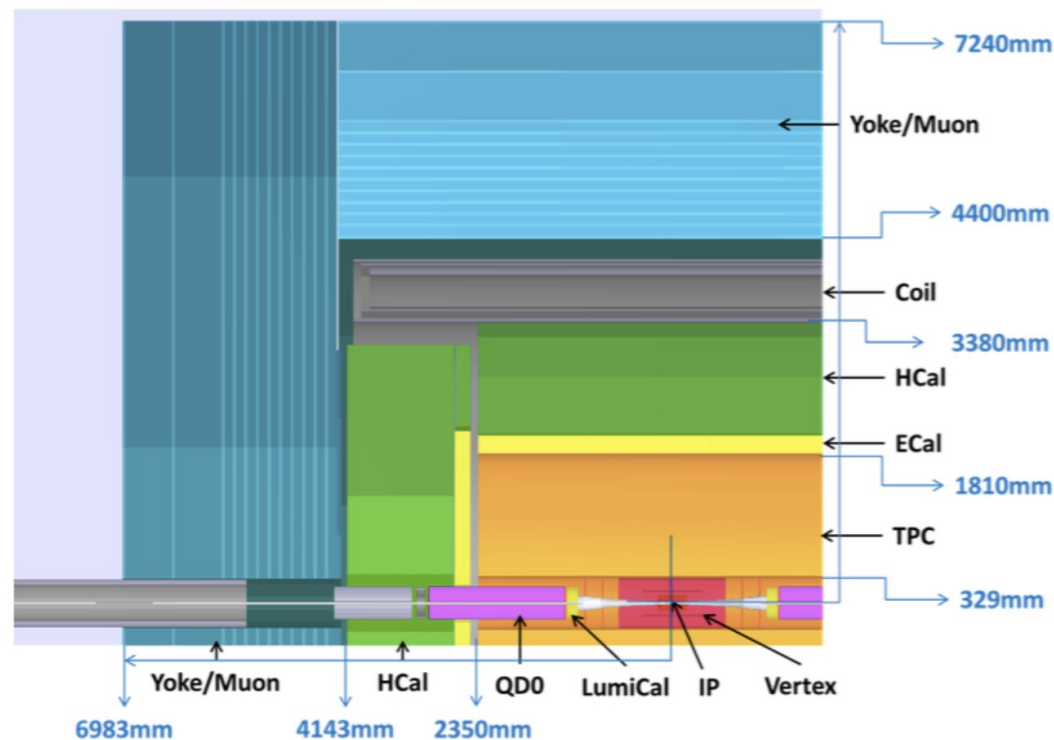
# CEPC Detector Overview

## Baseline: ILD-like

- TPC tracking + Imaging calorimetry (ECAL+HCAL)
- PFA-oriented

## Alternatives

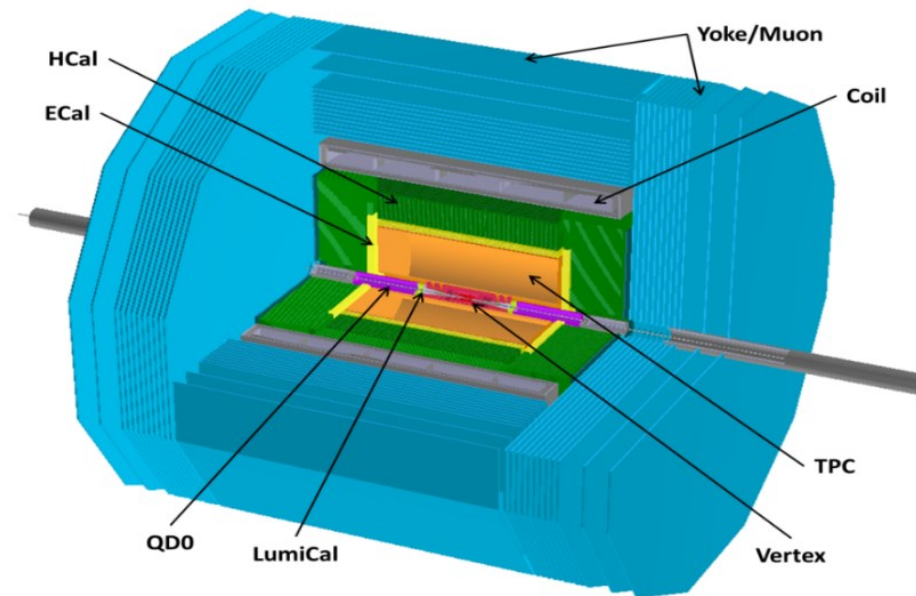
- Low-field concept
- Full-silicon concept



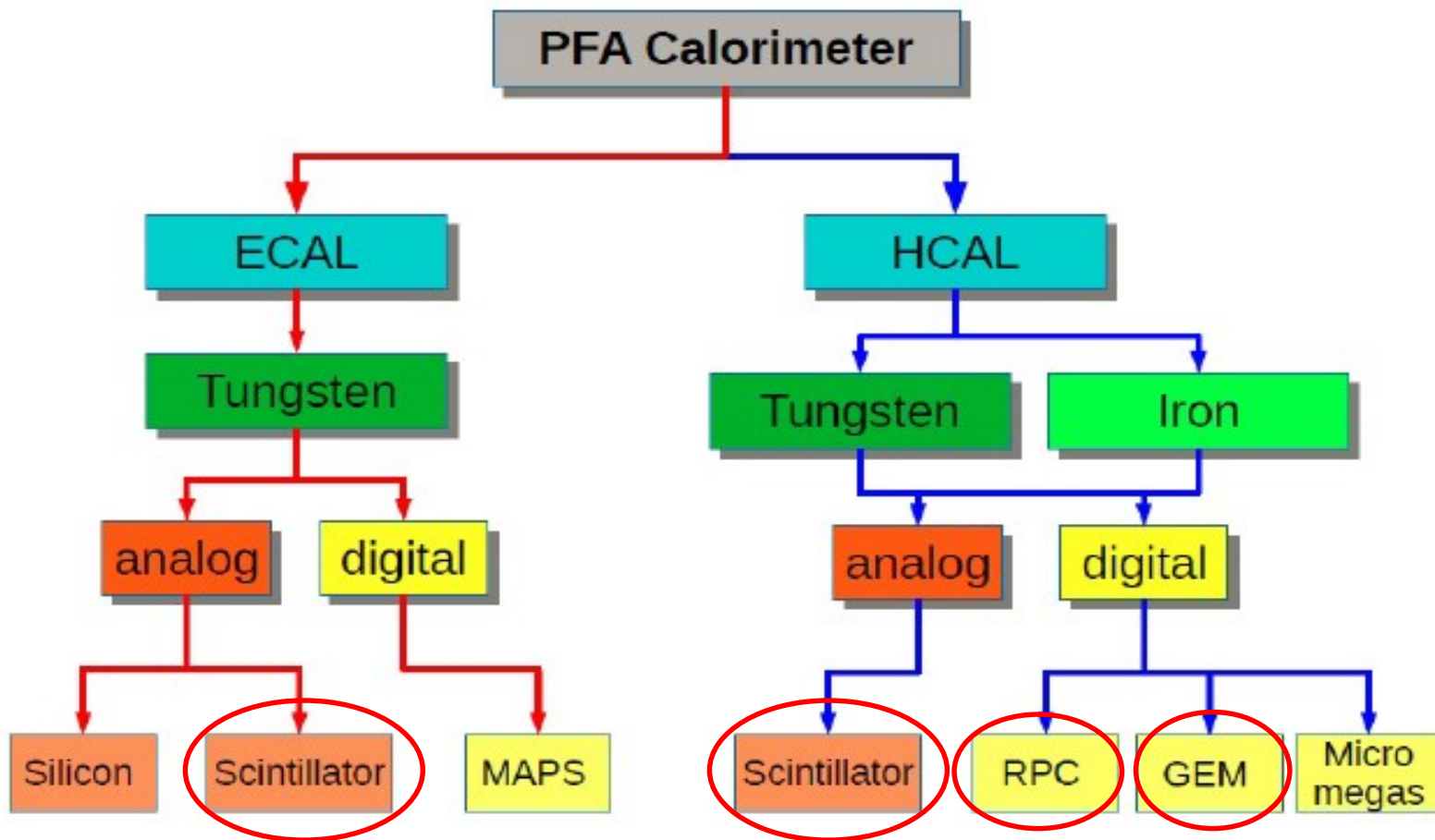
# CEPC Detector Overview

## Calorimeter Requirements

- Precise measurements of electrons and photons:
- $\sigma_E/E \approx 16\%/\sqrt{E} \oplus 1\%$
- Jet energy resolution (ECAL combined with HCAL and tracker):
- $\sigma_E/E \approx (3\% - 4\%)$
- Imaging detector with high granularity
  - Detailed information of showers
  - Compact showers (small  $X_0$ , and small  $R_M$ )
  - Minimum dead materials



# CEPC Calorimeter Options



## ECAL Option Covered

- Scintillator

## HCAL Option Covered

- Analog: Scintillator
- Digital: RPC, GEM/THGEM

# CEPC Calorimeter R&D

## China MOST CEPC R&D Phase-I project

- **Proposed and approved in 2016**
  - **Studies on physics and key technologies of a high-energy circular electron-positron collider**
- **Phase-II project also just approved (2018)**

## HCAL R&D efforts

- **Digital**
  - **RPC: SJTU & IPNL, Tsinghua ...**
  - **GEM/THGEM: USTC, IHEP, UCAS ...**
- **Analog**
  - **Scintillator: IHEP, USTC, BNU, SJTU ...**

## ECAL R&D efforts

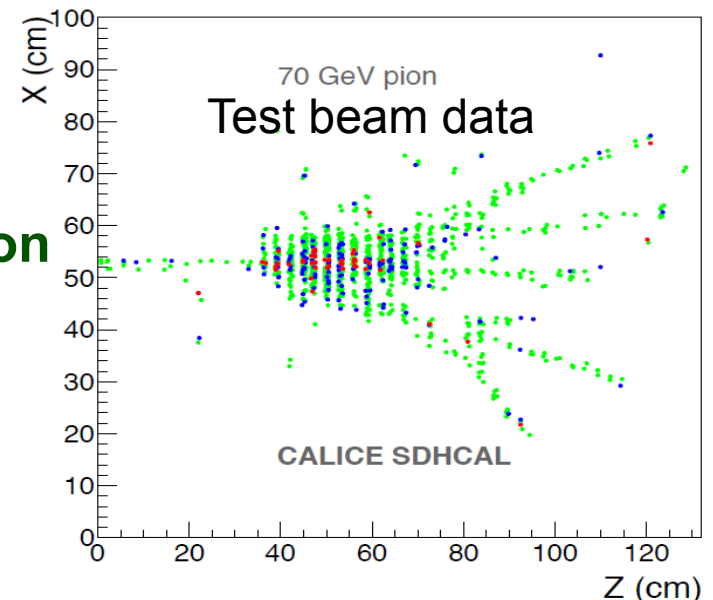
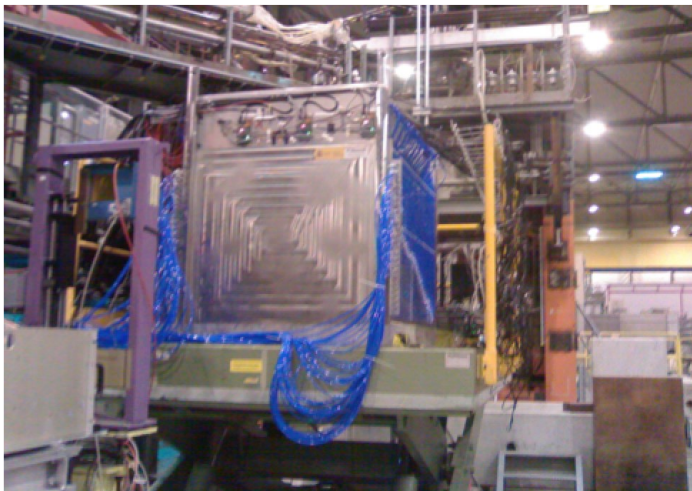
- **Analog**
  - **Scintillator: IHEP, USTC, BNU ...**

# SDHCAL Option: RPC

## RPC-SDHCAL R&D

Details @ [I. LAKTINEH's talk](#)

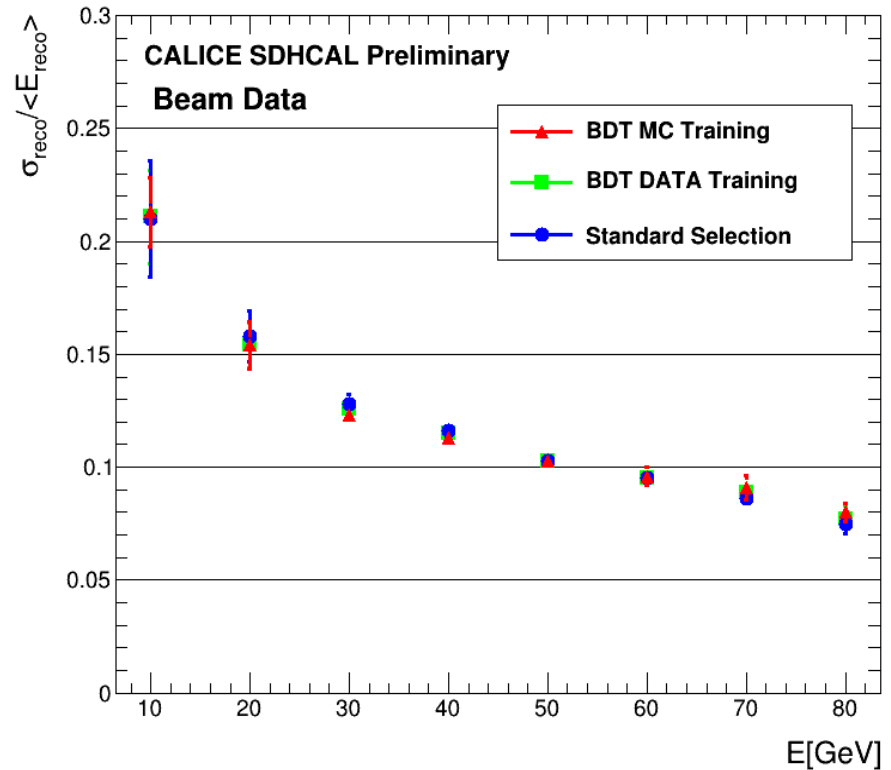
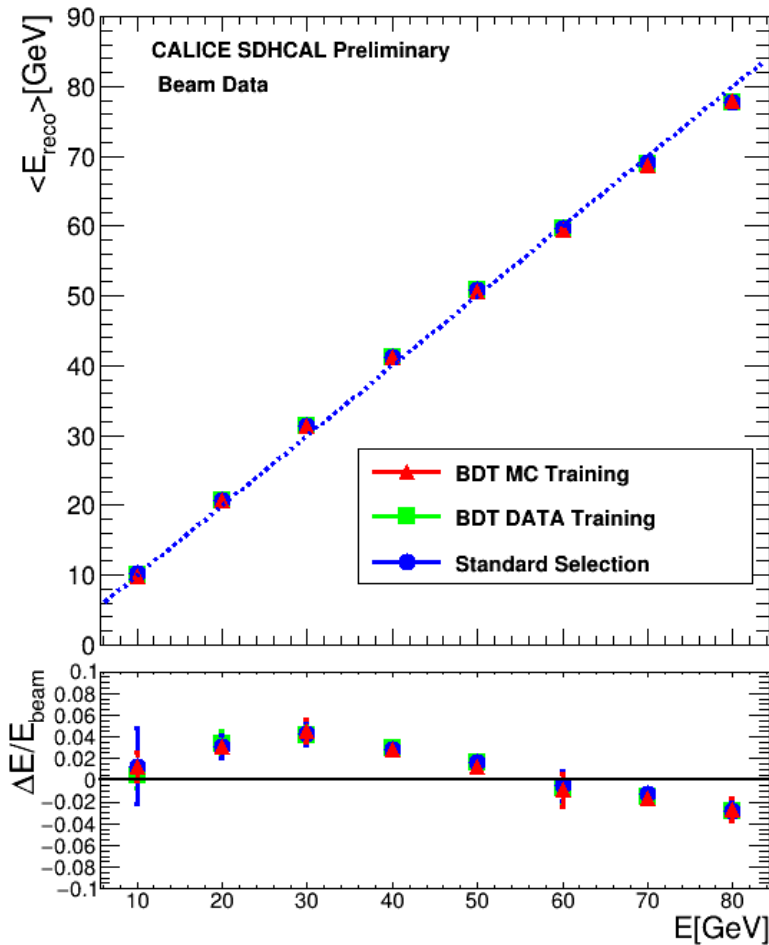
- IRPC-SDHCAL prototype (IPNL): first technological prototype of high-granularity calorimeters
- SJTU in close collaboration with IPNL, Tsinghua and several other groups within CALICE collaboration to work on RPC-SDHCAL R&D:
  - Particle ID
  - Energy reconstruction
  - Structure & geometry optimization



- Total Size:  $1.0 \times 1.0 \times 1.3 \text{ m}^3$
- Total Layers: 48
- # of Channels(pads): 440000

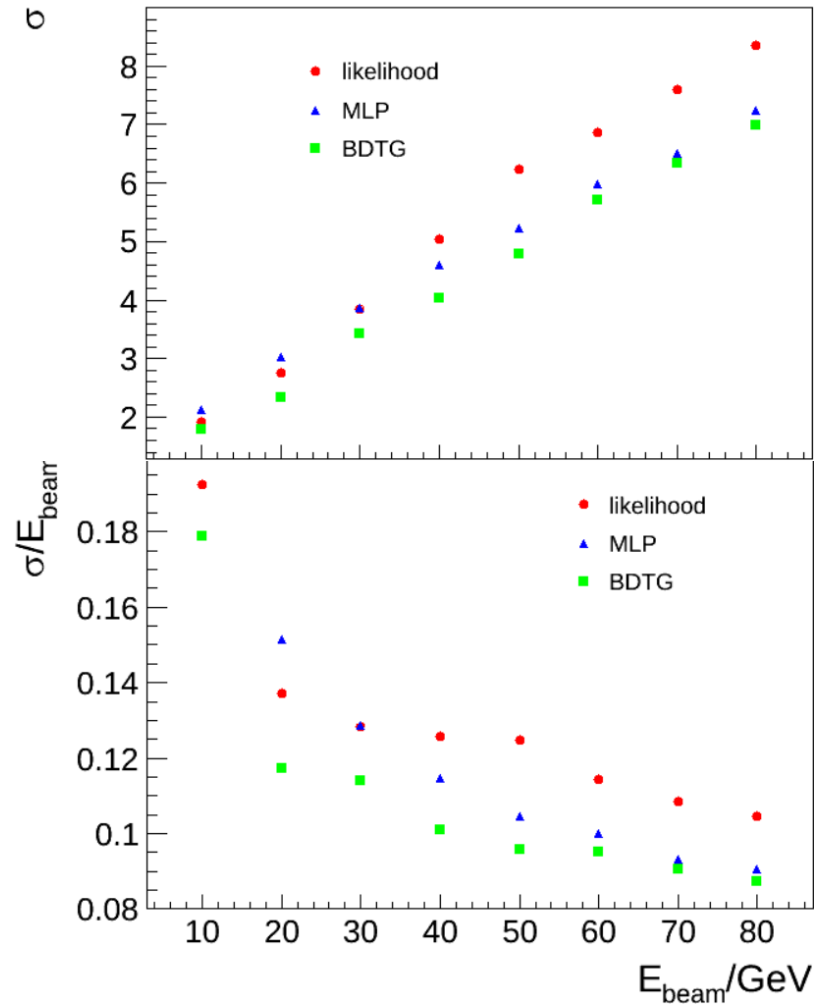
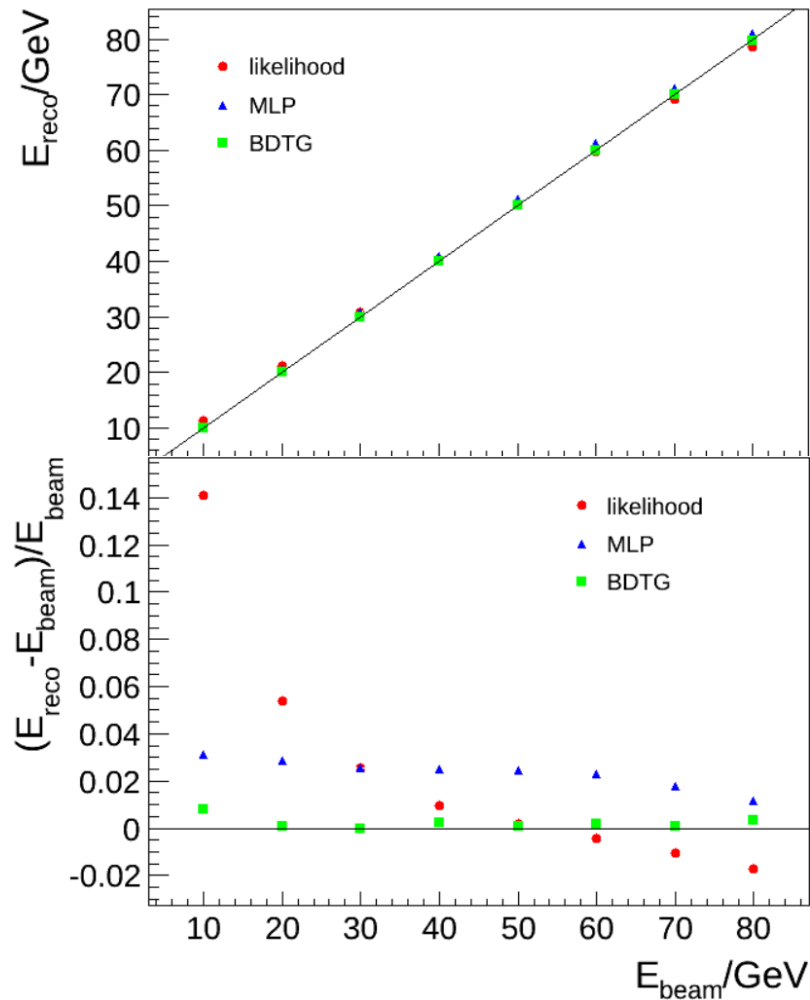
# SDHCAL Option: RPC

Details @ [I. LAKTINEH's talk](#)



Particle identification using BDT in SDHCAL

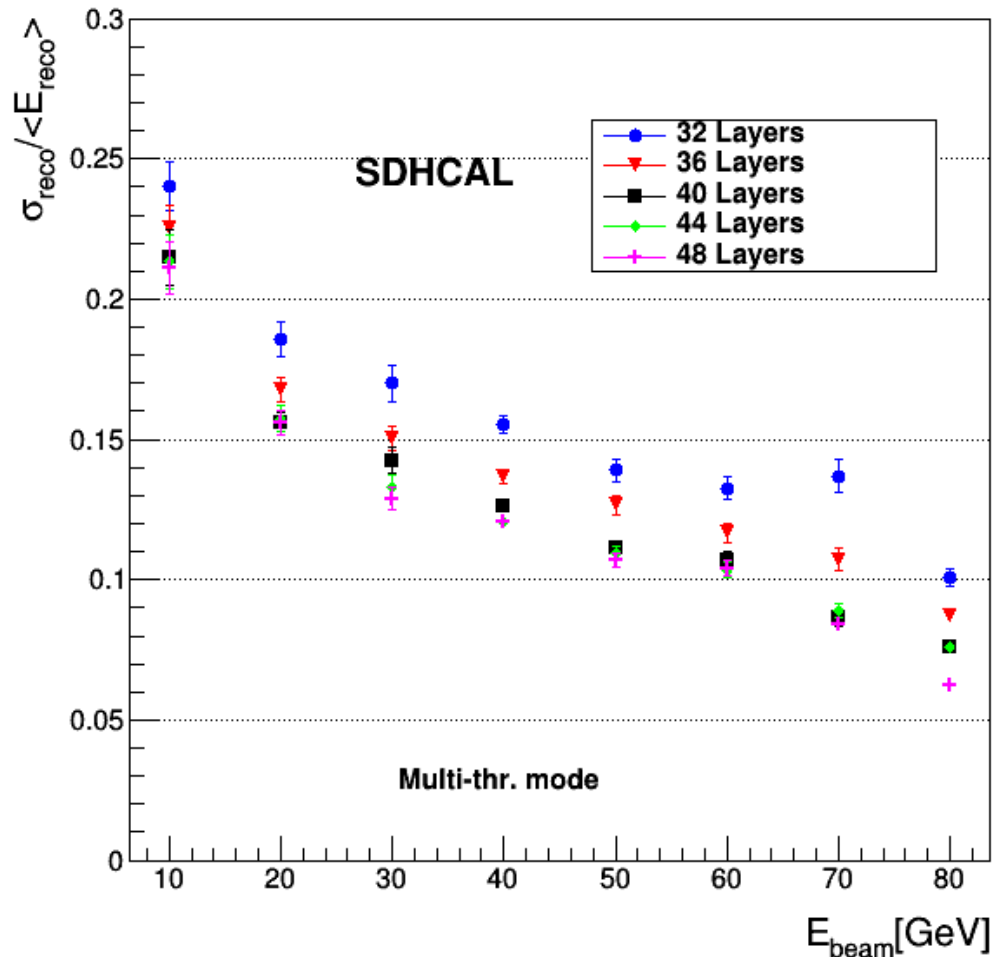
# SDHCAL Option: RPC



**Under development: comparison of different MVA reconstruction methods using simulated  $\pi^-$  samples**



# SDHCAL Option: RPC

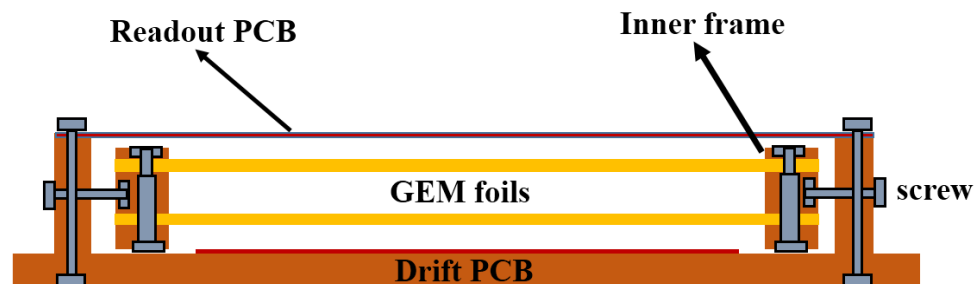


- RPC-SDHCAL has 48 layers, initially aims for ILC experiment
- Optimizing number of HCAL layers for CEPC at 240GeV
- 40 layers already yields decent energy resolution in CEPC regime

**RPC-SDHCAL structure and geometry optimization**

# SDHCAL Option: GEM

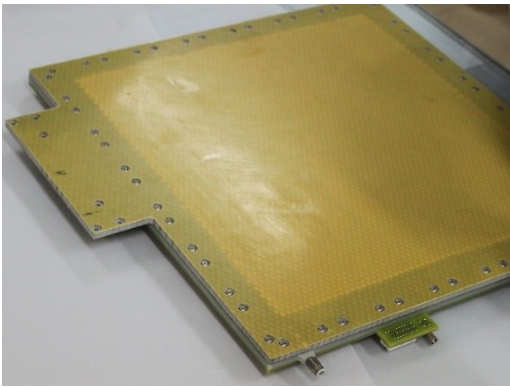
- **More compact GEM detector**
  - triple-GEM → double-GEM
- **Exploring double-GEM with self-stretching technique**
  - A purely mechanical method to assemble GEM detectors
  - Self-stretching technique very suitable for large-size GEM fabrication
    - No gluing, easy and fast assembly and labor saving
    - No inner spacers, no dead areas, smooth gas flow
    - Complete re-opening possible, highly replaceable and repairable
    - R&D ongoing



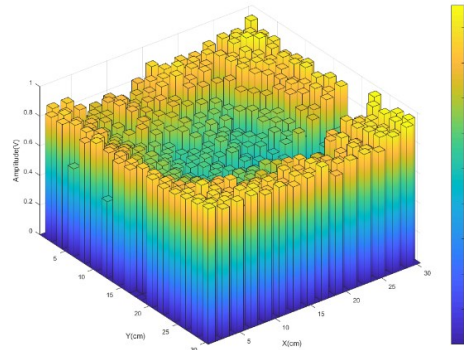
# DHCAL: GEM Option

- Built a 30cm\*30cm double-GEM prototype
- Tested the prototype with radiation source and cosmic-rays

Double-GEM prototype



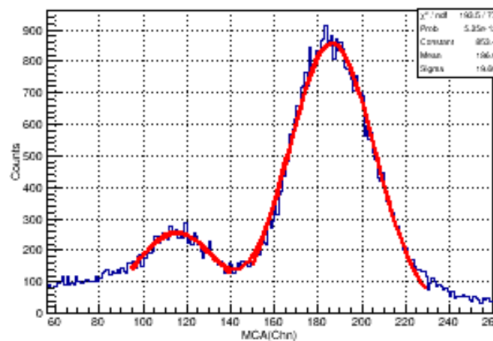
Gain uniformity: ~19%



Pad readout: 1cm\*1cm



Typical X-ray energy spectrum



- Cross-talk between neighboring channels: 1.5%
- MIP efficiency with Ar+CO<sub>2</sub> too low: 85% with HV on GEM foil @ 400V already
- High Ar percentage with a powerful quenching ingredient required: Ar/iC<sub>4</sub>H<sub>10</sub>(95/5) gives 99% efficiency

# DHCAL: THGEM Option

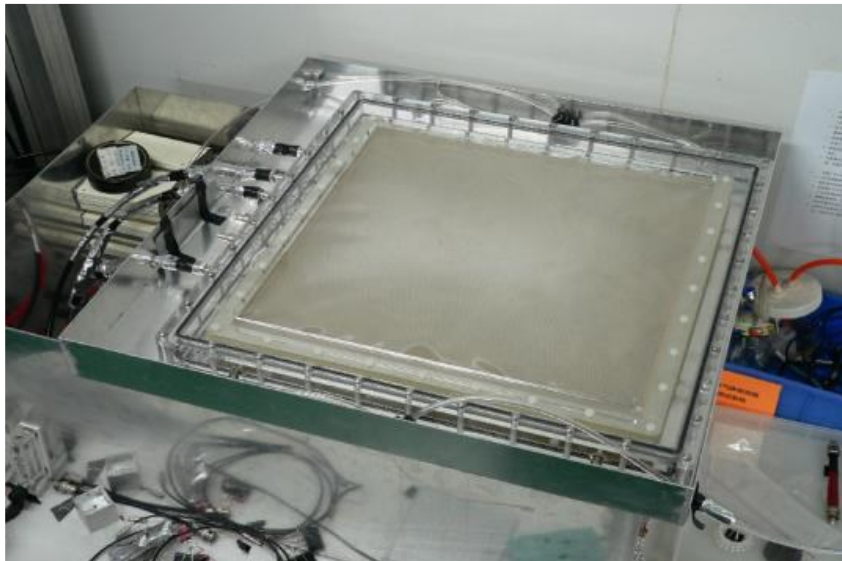
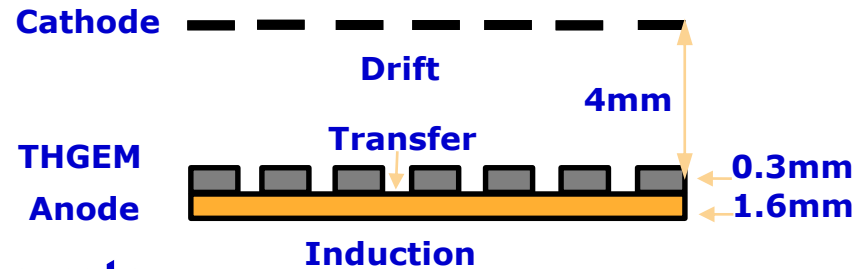
- Three detector structures with THGEM

- Double THGEM
- Single THGEM
- **WELL-THGEM**

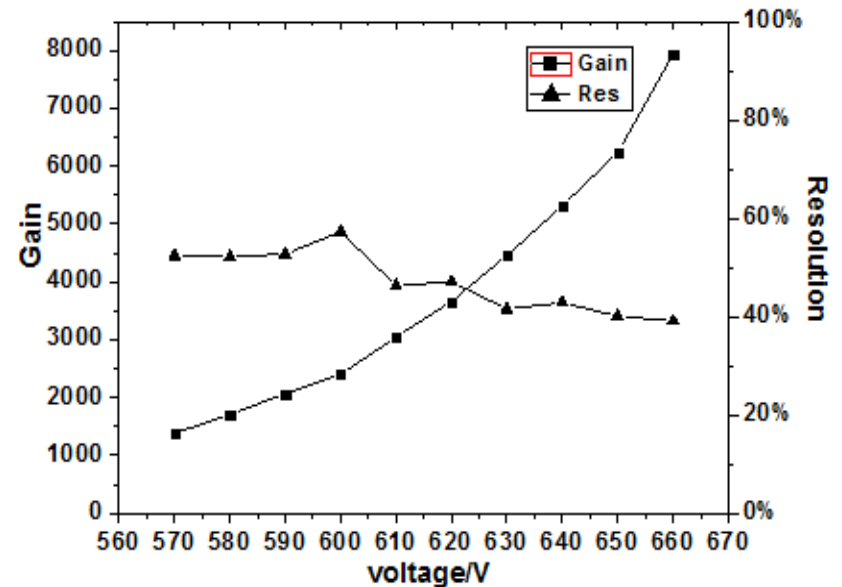
- Ideal option for HCAL
- Thinner, high gain, lower discharge rate
- R&D ongoing

40cm × 40cm THGEM

Thickness of WELL-THGEM < 6mm

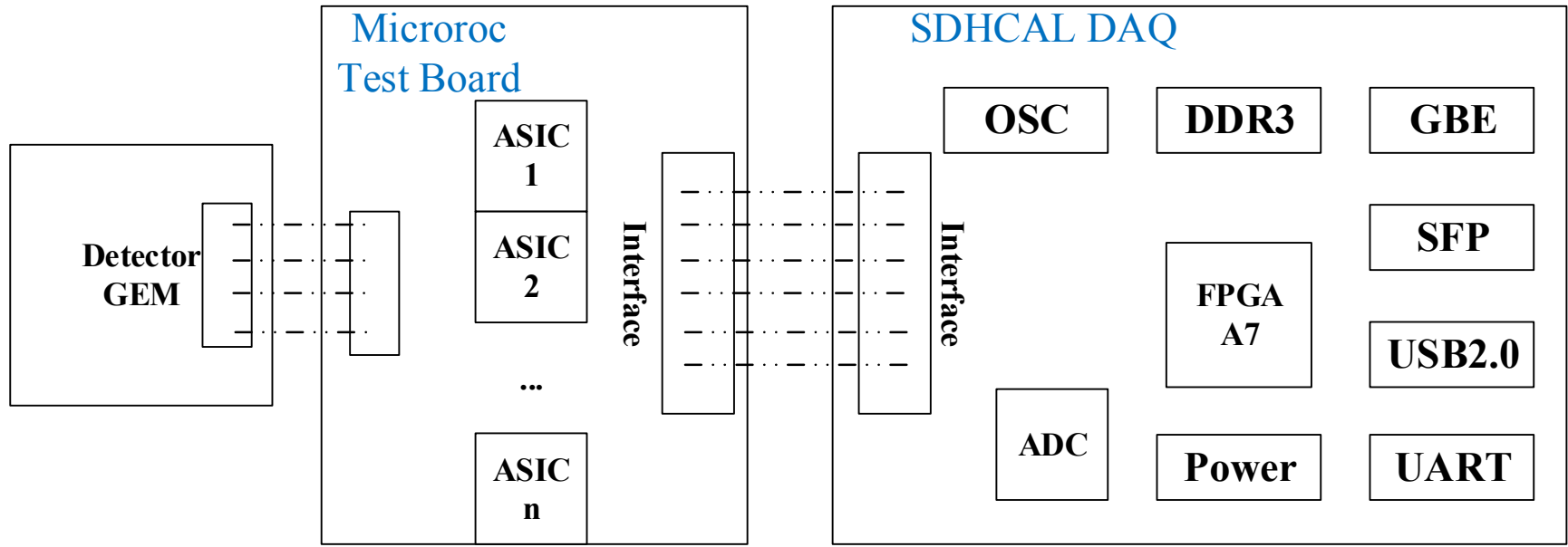


## Gain measured of WELL-THGEM



# DHCAL: GEM Option – Readout System R&D

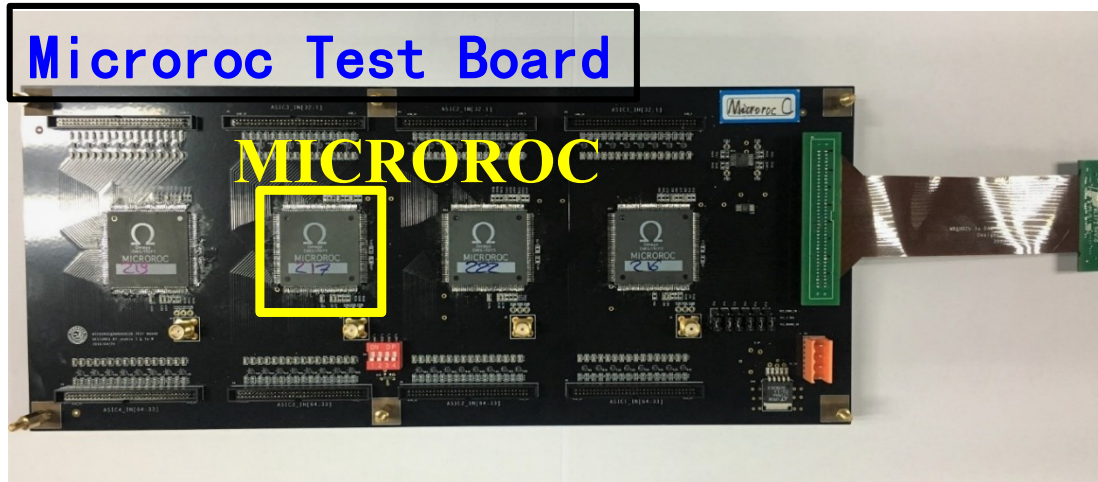
## Digital readout system schematic :



- GEM detector readout composed of 900 1cm<sup>2</sup> pads
- MICROROC Test Board: 4 MICROROC ASICs Mounted, controlled by daisy chain
- DIF Board: Microroc control, test and data acquisition

# DHCAL: GEM Option – PCB Board R&D

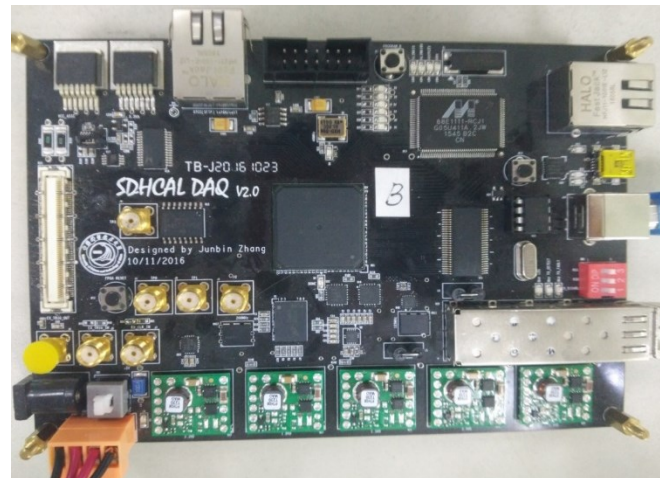
Microroc Test Board



## MICROROC Parameters

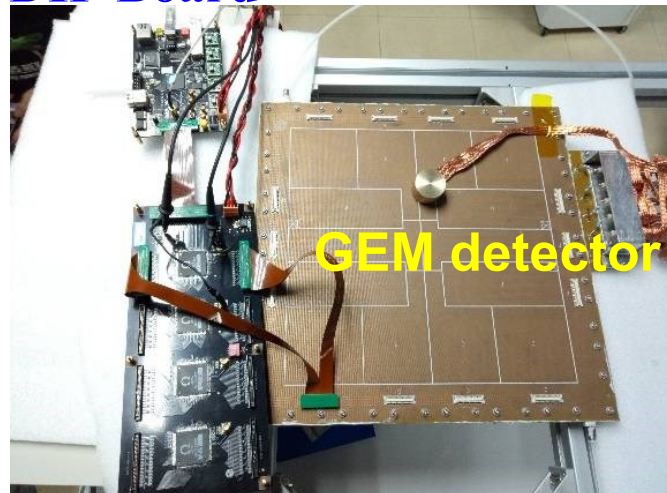
- ✓ Thickness: 1.4mm
- ✓ 64 Channels
- ✓ 3 threshold per channel
- ✓ 128 hit storage depth
- ✓ Minimum distinguishable charge: 2fC

DAQ Board



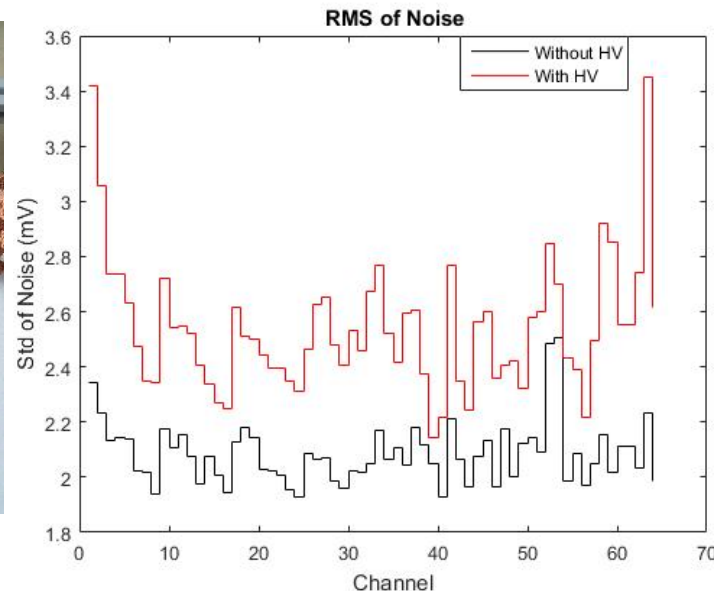
# DHCAL: GEM Option – Test of Readout System

DIF Board

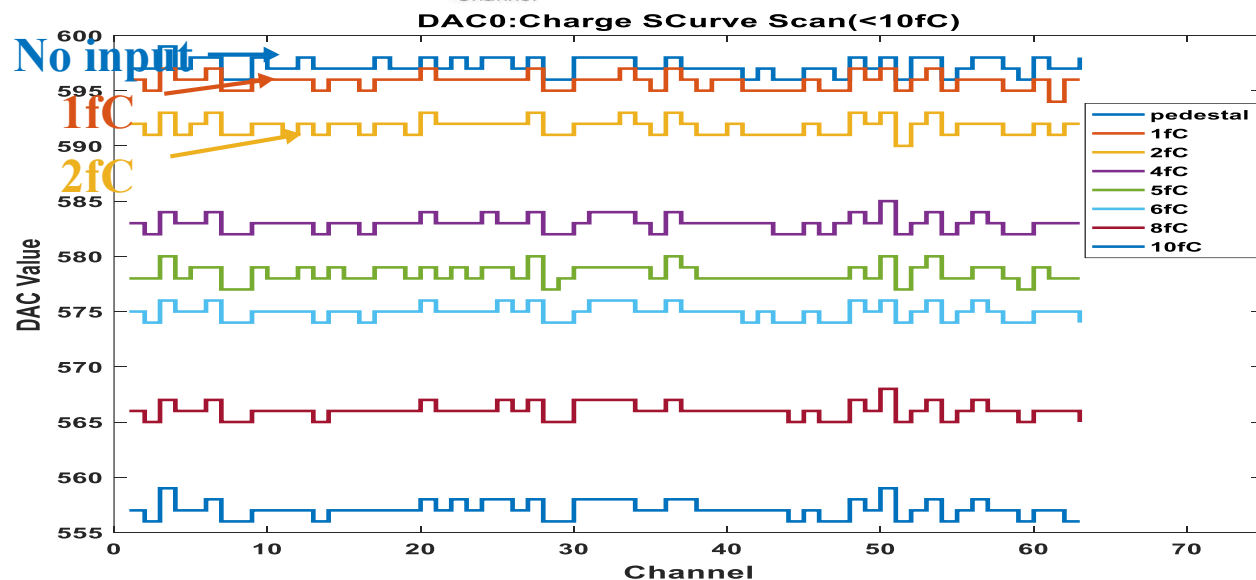


GEM detector

MICROROC Test Board



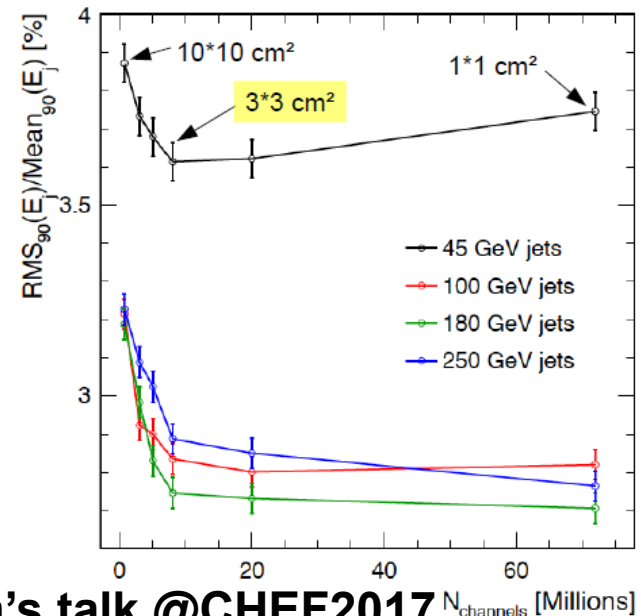
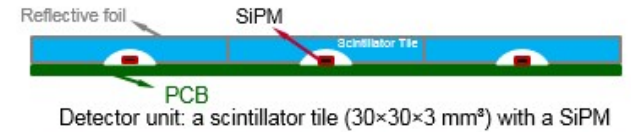
- Noise level without GEM detector  $\sim 0.25\text{fC}$
- Noise level with GEM detector  $\sim 0.35\text{fC}$



Uniformity check

# AHCAL: Scintillator Option

- Analog HCAL based on scintillator
  - The absorber: 2cm stainless steel
  - Base readout cell size: 3cm\*3cm
  - Readout chip: ASIC SPIROC2E
  - Sensitive detector : scintillator
  - Total number of readout channels of HCAL with 40 layers:
    - ~ 5 M (3cm\*3cm)
    - ~ 3 M (4cm\*4cm)

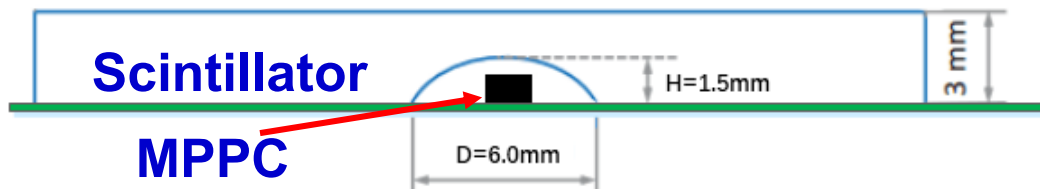


Katja's talk @CHEF2017 N<sub>channels</sub> [Millions]

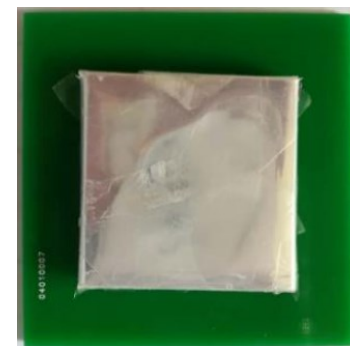
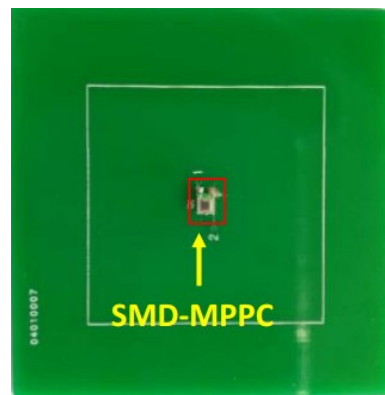
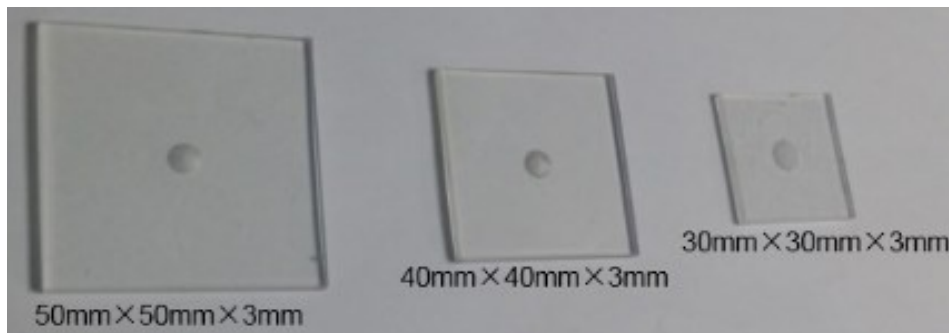


# AHCAL: Scintillator Option – Detector Cell

- A dome-shaped cavity is made at the center of plastic scintillator tile via mechanical drilling and polishing
- Surface-mounted SiPM for light readout
- Scintillator(BC408) tile wrapped by ESR foil
- Tile sizes variation:  $30 \times 30 \times 3\text{mm}^3$ ,  $30 \times 30 \times 2\text{mm}^3$ ,  $40 \times 40 \times 3\text{mm}^3$ ,  $50 \times 50 \times 3\text{mm}^3$

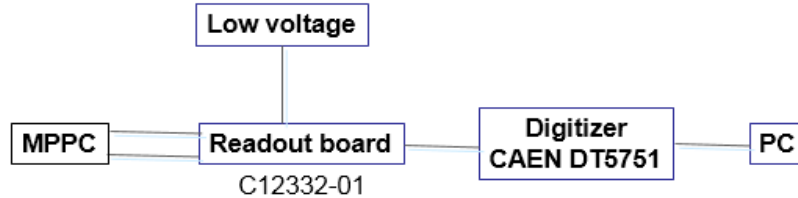
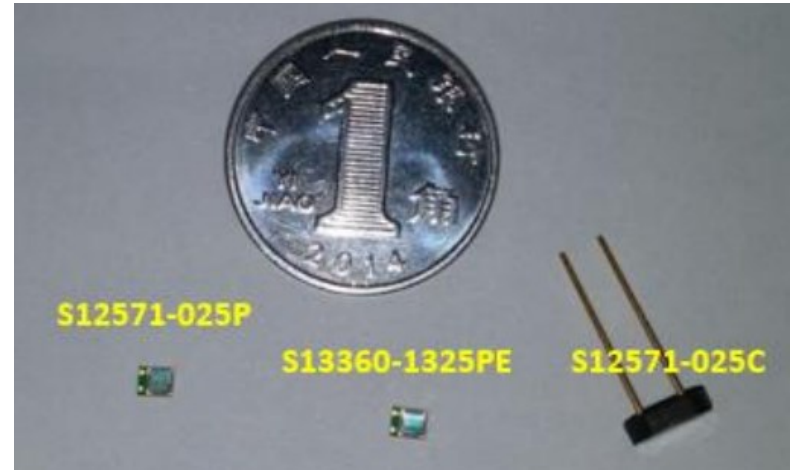


Scintillator tile wrapped by ESR foil was glued on the PCB



# AHCAL: Scintillator Option - Readout Test

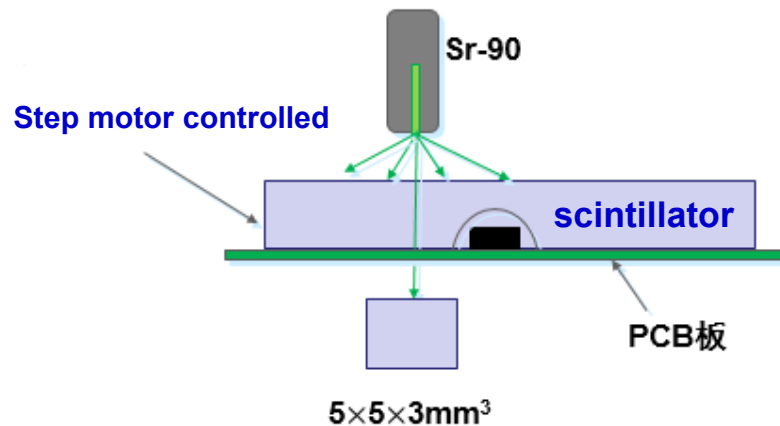
- Hamamatsu C12332-01 readout board
- Built-in temperature compensation keeps SiPM response stable



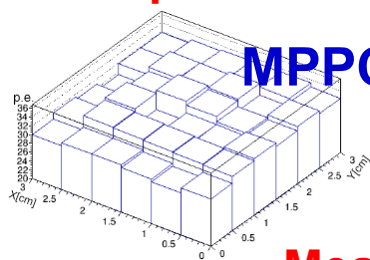
**S12571-025P specs**  
Sensitive area :  $1 \times 1 \text{mm}^2$   
Pixel size :  $25 \times 25 \mu\text{m}^2$   
Pixel number: 1600  
Gain:  $5.15\text{E}+05$

**S13360-1325PE specs:**  
Sensitive area :  $1.3 \times 1.3 \text{mm}^2$   
Pixel size :  $25 \times 25 \mu\text{m}^2$   
Pixel number: 2668  
Gain:  $1.1\text{E}+06$

# AHCAL: Scintillator Option – Cell Response Uniformity

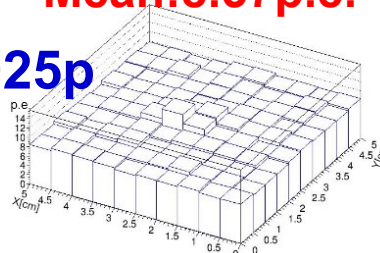


Mean: 32.2 p.e.



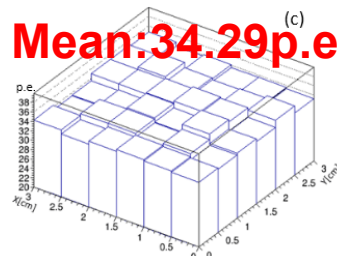
$30 \times 30 \times 3 \text{mm}^3$

Mean: 8.57 p.e.



$50 \times 50 \times 3 \text{mm}^3$

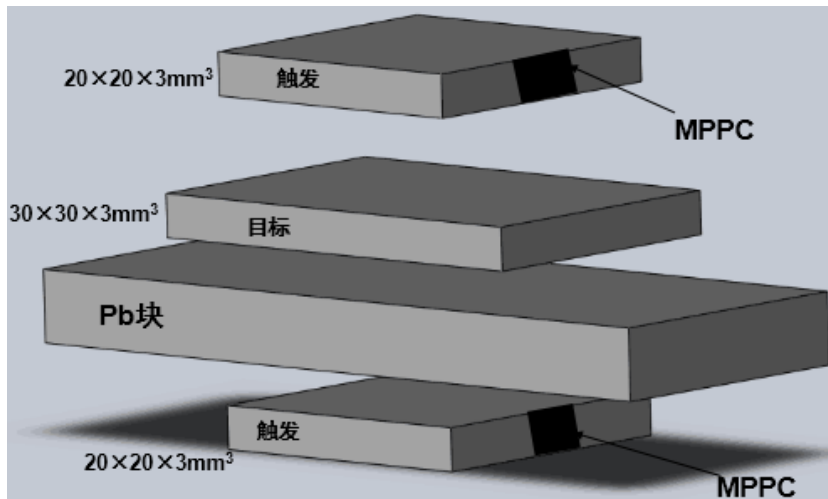
Mean: 34.29 p.e. (c)



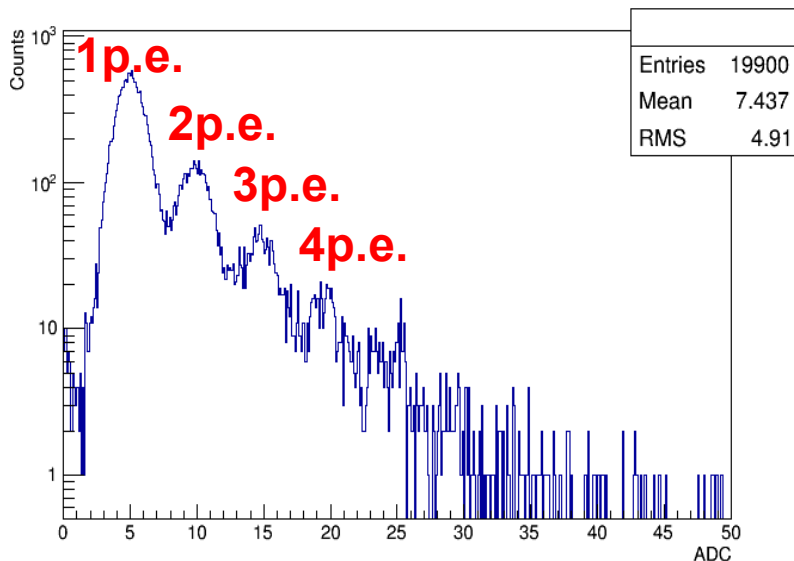
$30 \times 30 \times 2 \text{mm}^3$

Uniformity ~ 10%

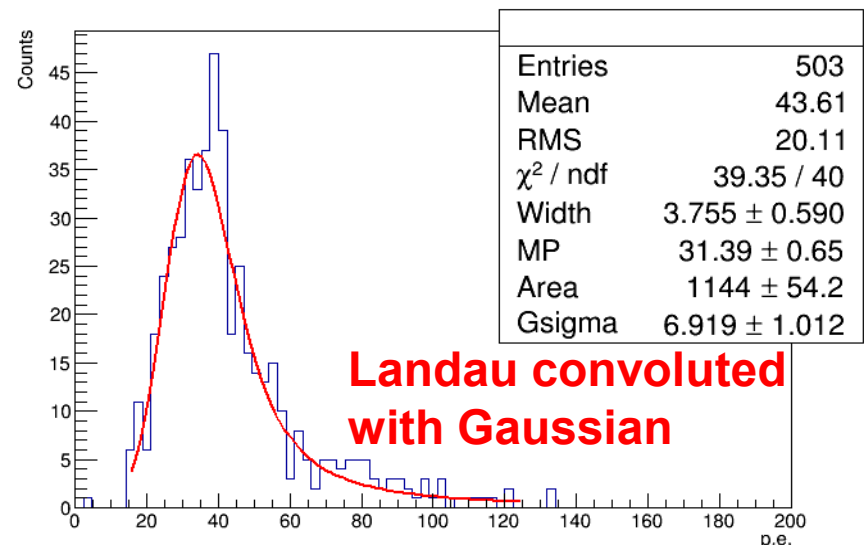
# AHCAL: Scintillator Option – Cosmic-ray Test



- $30 \times 30 \times 3 \text{mm}^3$ ,  $30 \times 30 \times 2 \text{mm}^3$ ,  $40 \times 40 \times 3 \text{mm}^3$ ,  $50 \times 50 \times 3 \text{mm}^3$
- SiPM type: S12571-025p, S13360-1325PE



SiPM dark count spectrum



Cosmic-ray energy spectrum

# AHCAL: Scintillator Option - Test Results

**Table 1** Cosmic-ray measurement results of detector cells with different sizes<sup>⌘</sup>

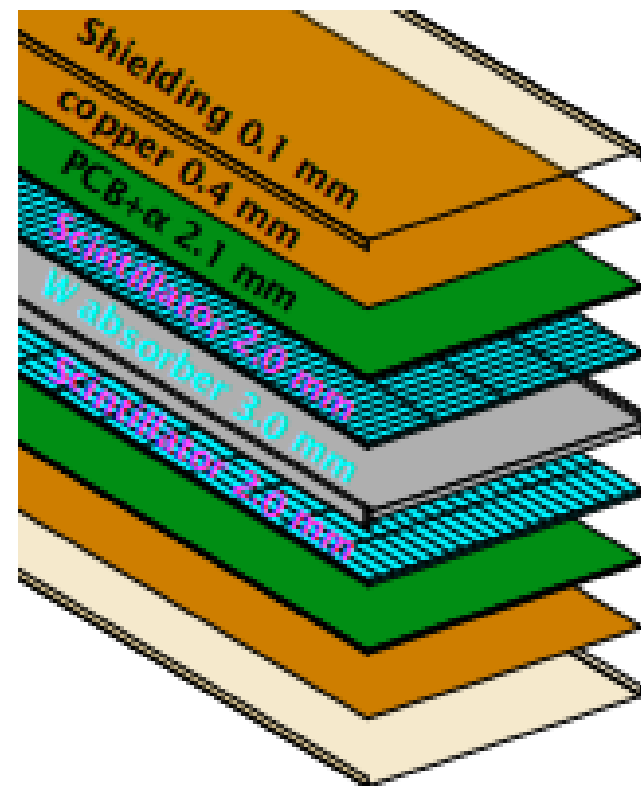
No. <sup>⌘</sup>	Detector Cell <sup>⌘</sup>	MPPC Type <sup>⌘</sup>	Reflective Foil Type <sup>⌘</sup>	Mean $N_{p.e.}$ <sup>⌘</sup>	Polishing Methods <sup>⌘</sup>
1 <sup>⌘</sup>	30×30×3mm <sup>3⌘</sup>	S12571-025P <sup>⌘</sup>	ESR <sup>⌘</sup>	31.39±0.65 <sup>⌘</sup>	Ultra Precise Polishing <sup>⌘</sup>
2 <sup>⌘</sup>	30×30×3mm <sup>3⌘</sup>	S12571-025P <sup>⌘</sup>	ESR <sup>⌘</sup>	22.55±0.7 <sup>⌘</sup>	Precise Polishing <sup>⌘</sup>
3 <sup>⌘</sup>	30×30×3mm <sup>3⌘</sup>	S12571-025P <sup>⌘</sup>	ESR <sup>⌘</sup>	18.92±0.39 <sup>⌘</sup>	Rough Polishing <sup>⌘</sup>
4 <sup>⌘</sup>	30×30×3mm <sup>3⌘</sup>	S12571-025P <sup>⌘</sup>	TYVEK <sup>⌘</sup>	13.63±0.33 <sup>⌘</sup>	Precise Polishing <sup>⌘</sup>
5 <sup>⌘</sup>	40×40×3mm <sup>3⌘</sup>	S12571-025P <sup>⌘</sup>	ESR <sup>⌘</sup>	14.89±0.73 <sup>⌘</sup>	Precise Polishing <sup>⌘</sup>
6 <sup>⌘</sup>	50×50×3mm <sup>3⌘</sup>	S12571-025P <sup>⌘</sup>	ESR <sup>⌘</sup>	9.87±0.43 <sup>⌘</sup>	Precise Polishing <sup>⌘</sup>
7 <sup>⌘</sup>	30×30×2mm <sup>3⌘</sup>	S13360-1325PE <sup>⌘</sup>	ESR <sup>⌘</sup>	33.89±0.49 <sup>⌘</sup>	Precise Polishing <sup>⌘</sup>

- MIP responses in most of the above cell configurations are rather efficient
- Optimized detector cell size: 30\*30\*2mm<sup>3</sup>

# ECAL: Scintillator Option

## ECAL with scintillator option

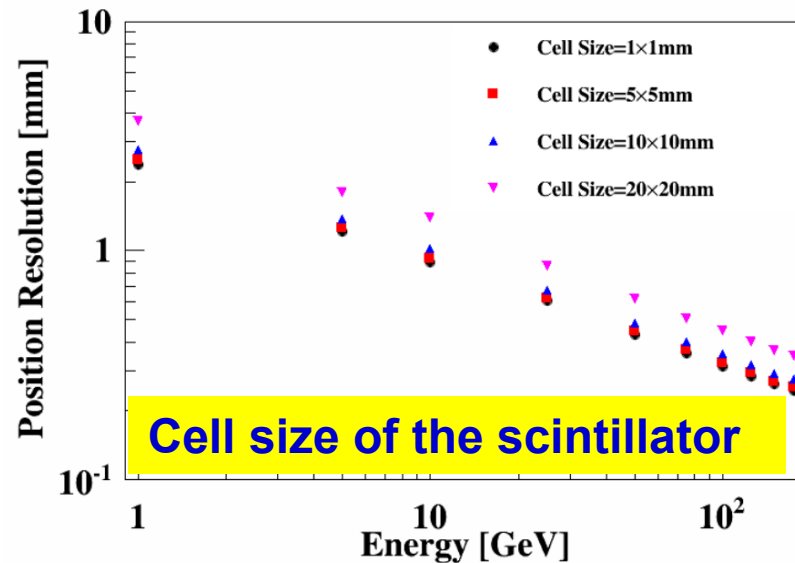
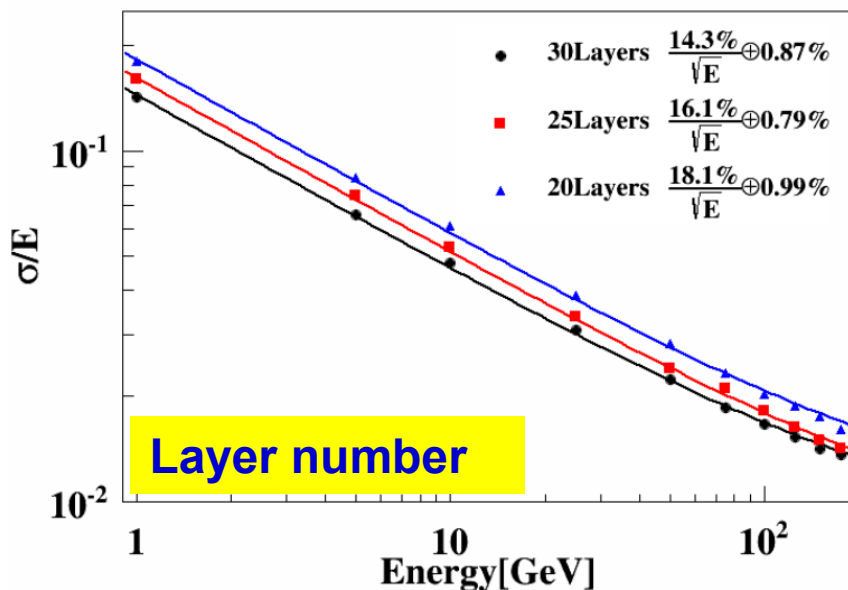
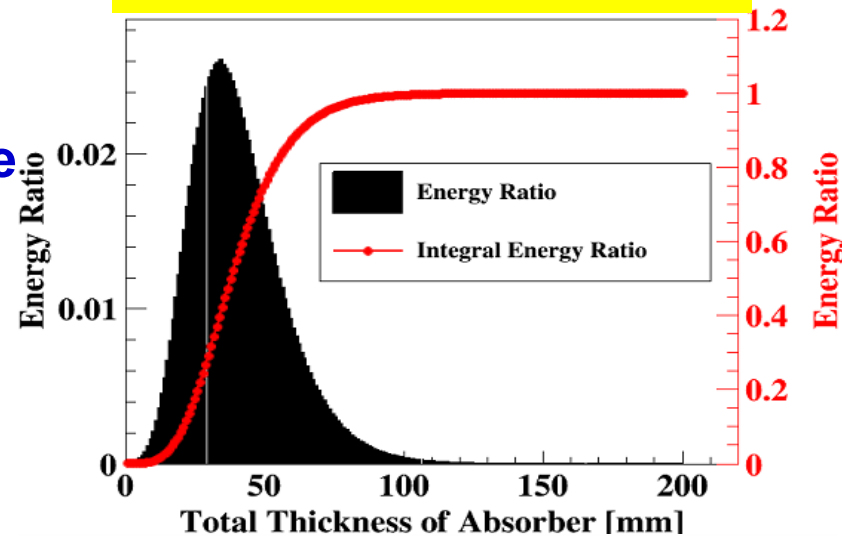
- A sampling calorimeter with scintillator-tungsten sandwich structure (ScW)
  - Sandwich structure: absorber + scintillator readout module + PCB
  - Scintillator readout module: Scintillator + SiPM
  - Absorber: Tungsten



# ECAL: Scintillator Option – Design Optimization

- Structure and geometry optimization done using simulation samples
- Thickness of the absorber, layer number, cell size and thickness of the scintillator
  - Thickness: 80~90mm
  - Layer number: 30

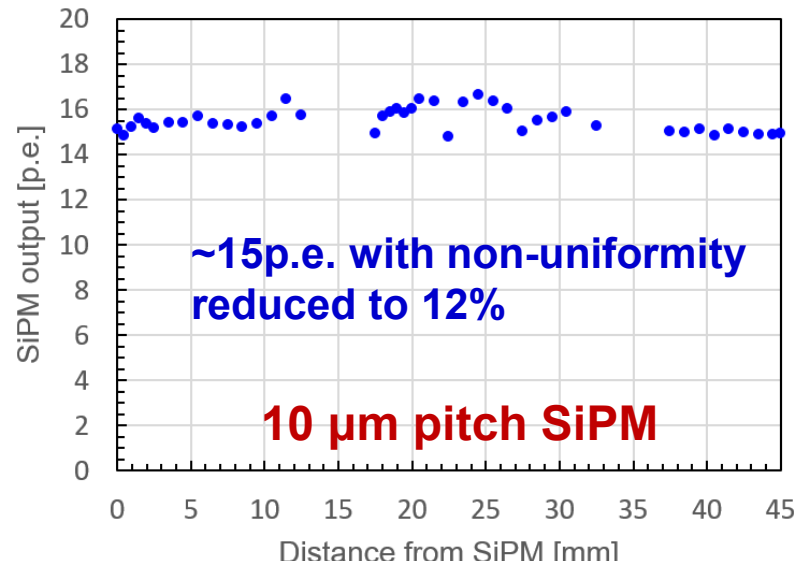
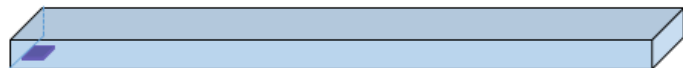
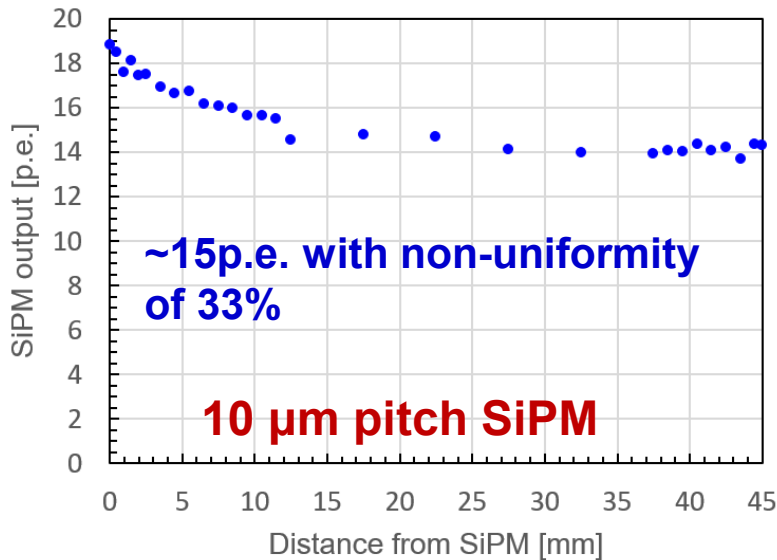
Thickness of the absorber



# ECAL: Scintillator Option – Module Simulation

**Standalone Geant4 simulation is used to optimize scintillator module**

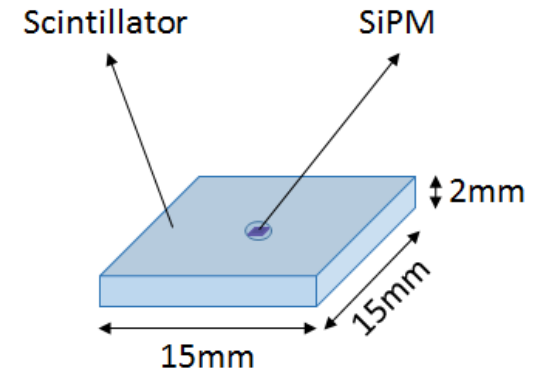
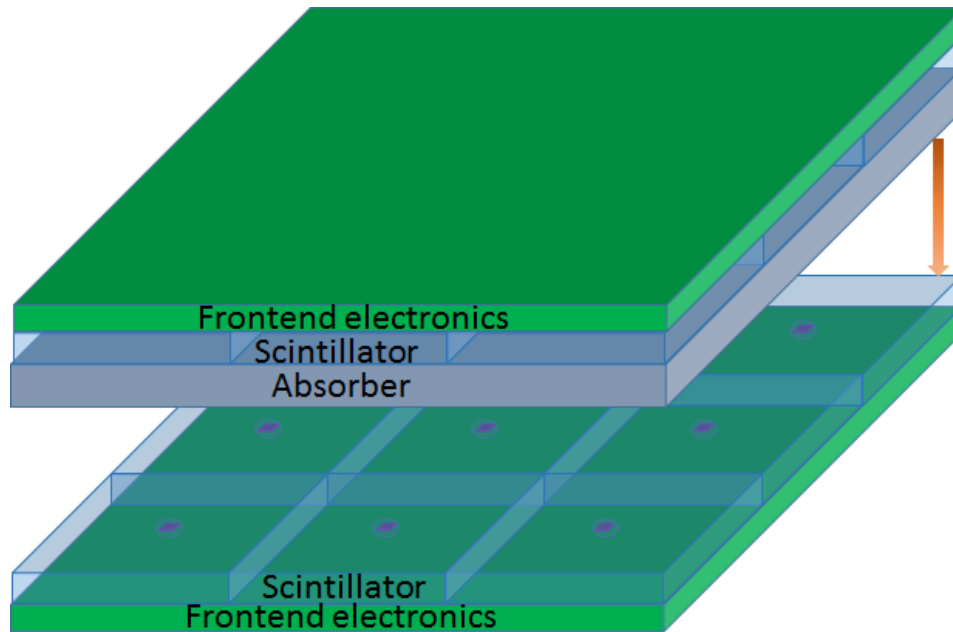
- **PhysicsList: QGSP\_INCLXX + Standard Geant4 Optical Physics (Version: Geant 4.10.3)**
- **Scintillator Strip: BC408, dimension:  $45 \times 5 \times 2 \text{mm}^3$**
- **SiPM:  $1 \times 1 \times 0.1 \text{mm}^3$  , Pitch size  $25 \mu\text{m}$ , 1600pixel**
- **Cladding: ESR, Tyvek**
- **Particle source: Sr-90, Center of the Strip, Vertical incidence**



**The bottom-center coupled mode is chosen for the prototype**

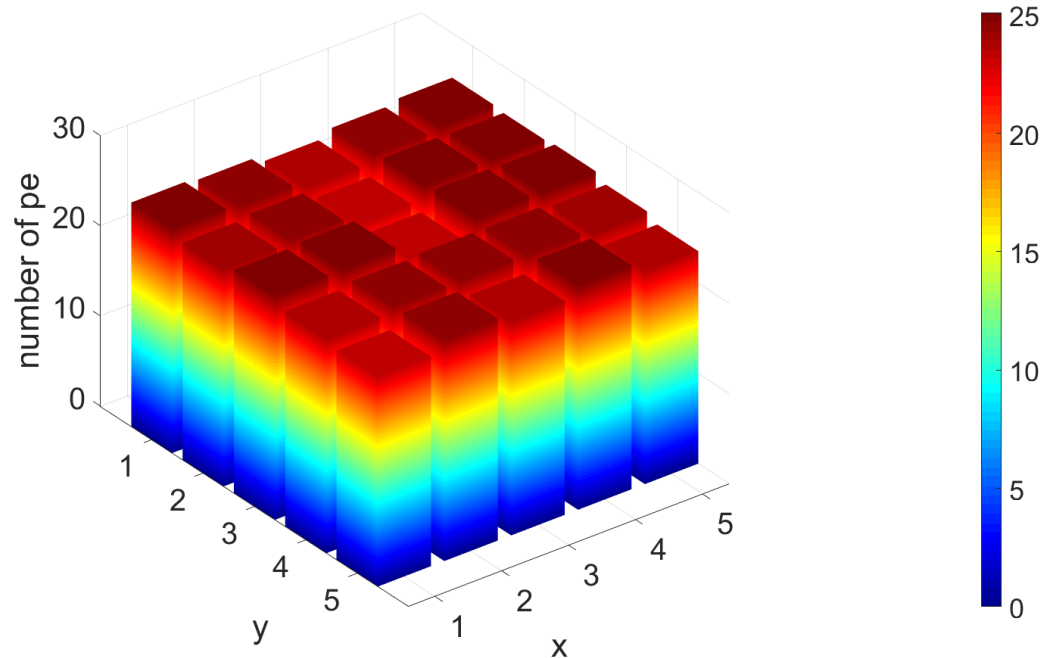
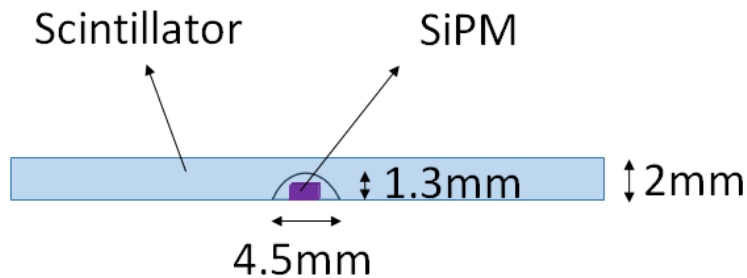


# ECAL: Scintillator Option – Module Optimization



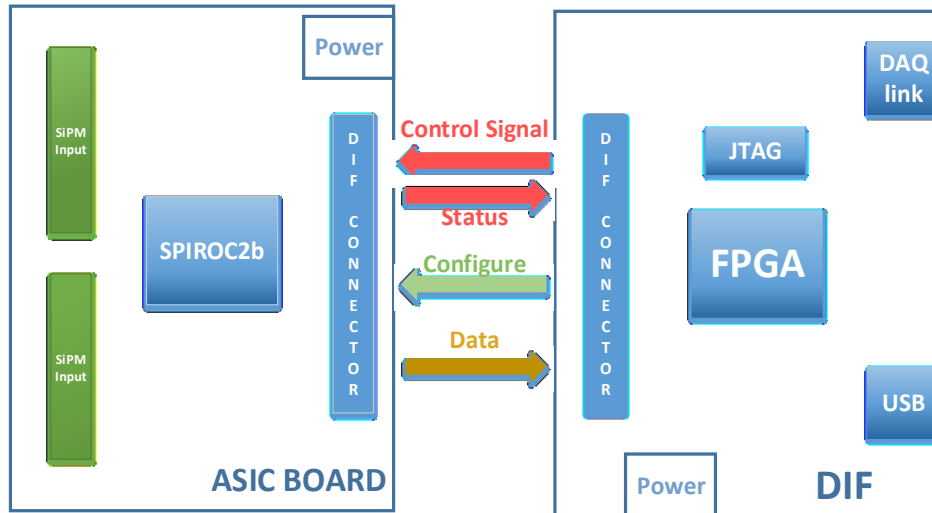
- Both strip and square scintillator modules tested and compared
  - Total number of the modules the same
- Geant4 simulation results suggest the cell size of square module could be enlarged to  $15\text{mm} \times 15\text{mm}$
- SiPM embedded into the dome-shaped cavity of the scintillator
- Relative simple reconstruction algorithm
- No dead area

# ECAL: Scintillator Option – Square Module Test



- **Module output: 22 p.e. for MIP, slightly higher than strip module**
- **Better output uniformity (<10%) than strip module**
- **Further tests are needed**

# ECAL: Scintillator Option – Readout System R&D

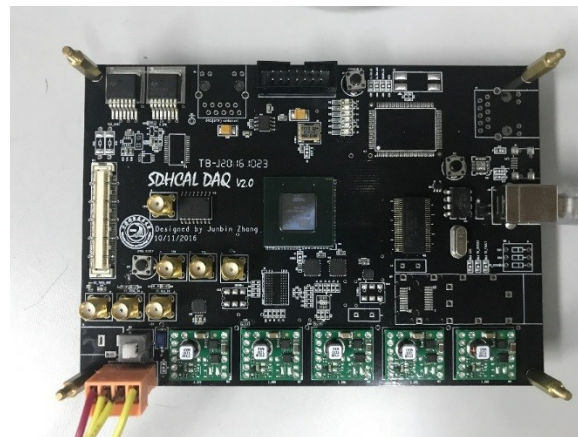


Readout System Schematic

- ASIC board is developed with **SPIROC2b** chip, which performs amplification, auto-triggering, digitization and zero-suppression
- DIF plays the role of collecting data and configuring chip before system running
- USB for data upload & commands sending
- USB for single DIF, and serial port for DAQ when using multiple DIF

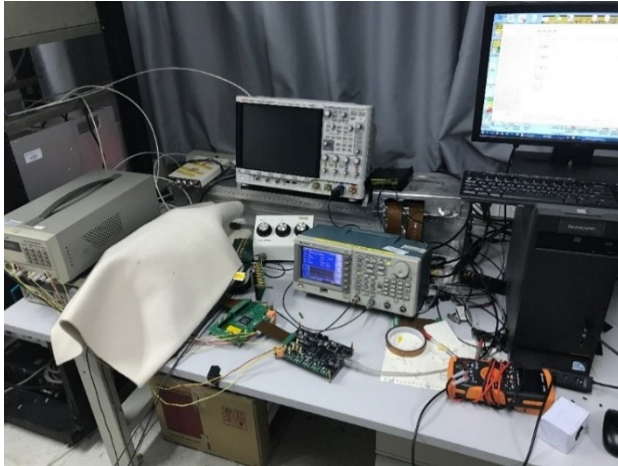


FEB

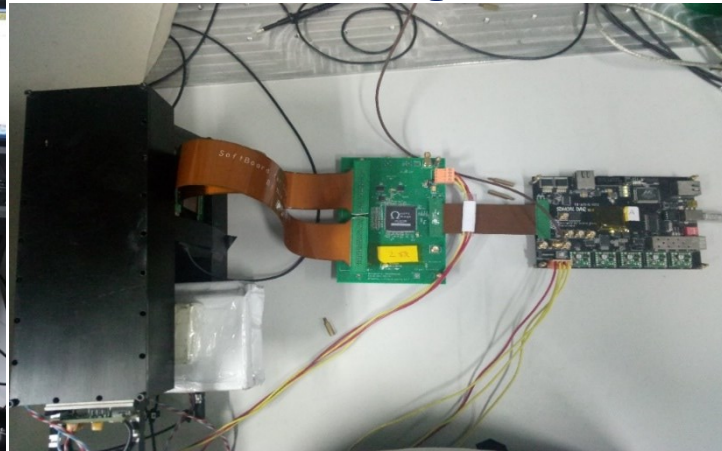


DIF

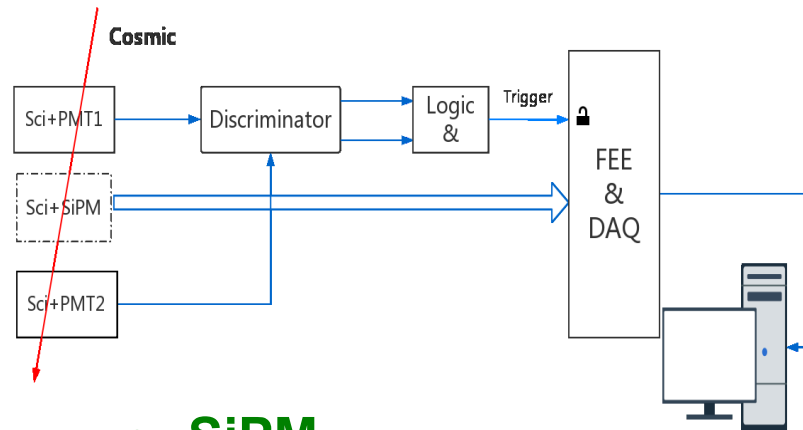
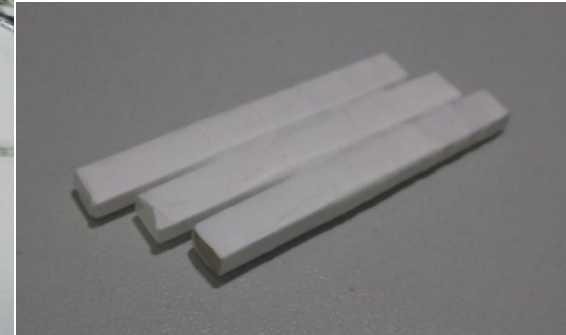
# ECAL: Scintillator Option – Cosmic-ray Test



**Test Platform**



**Cosmic ray test**



- **SiPM**

- S12571-010P
- 1mm × 1mm
- 10k pixels

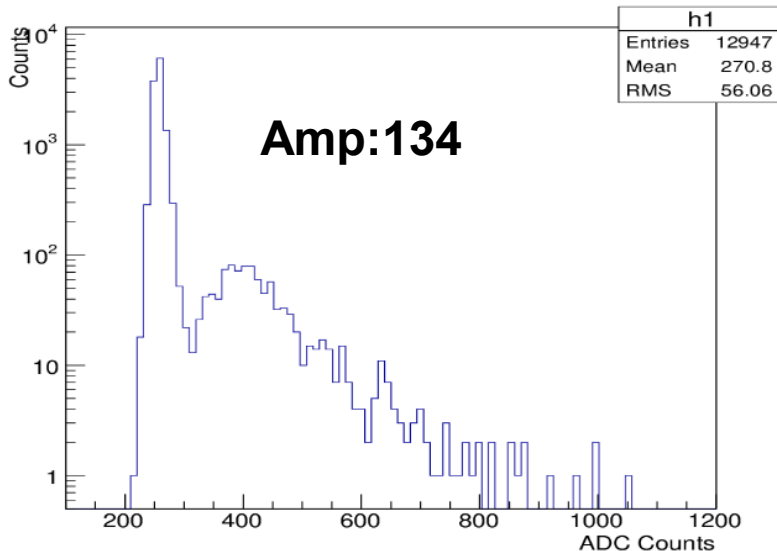
- **Three different scintillator materials were tested using cosmic rays**

- **Plastic scintillator**
  - BC408
  - EJ200
- **Crystal**
  - BGO crystal

# ECAL: Scintillator Option – Cosmic-ray Test

**EJ200**

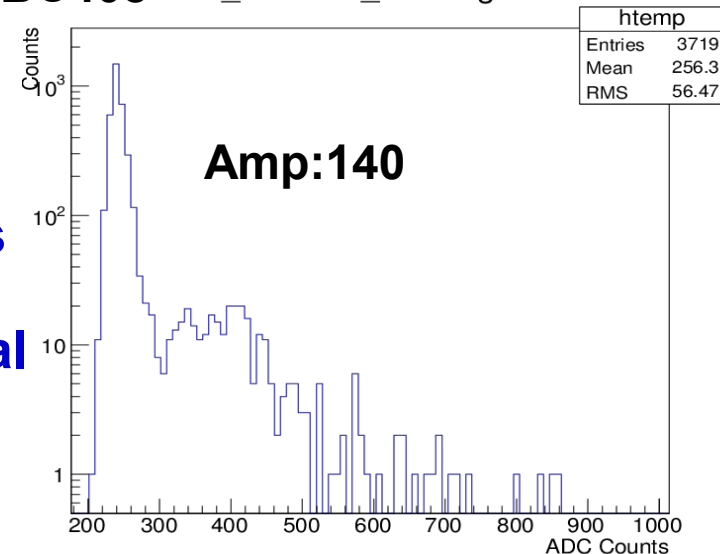
200ohm Test Results



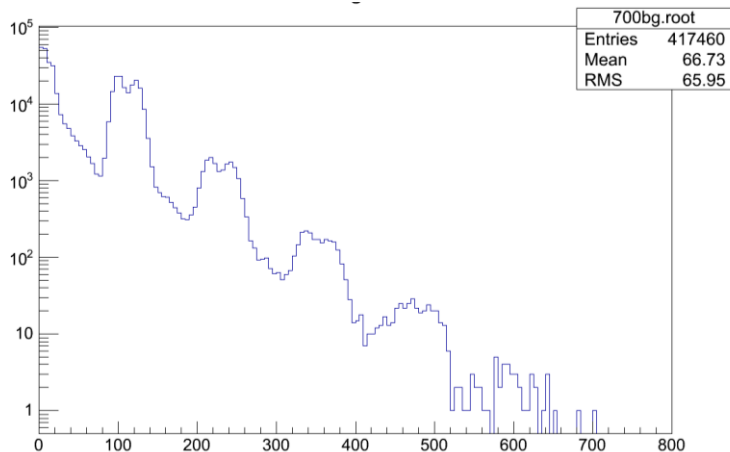
- Peak of MIPs separated from pedestal clearly

**BC408**

H\_Channel\_9.Chargers



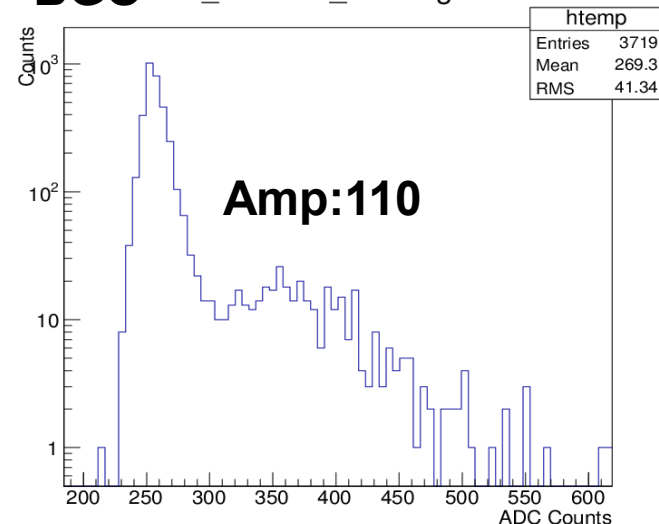
- Electronics working with good performance



**Spectrum of SiPM dark noise**

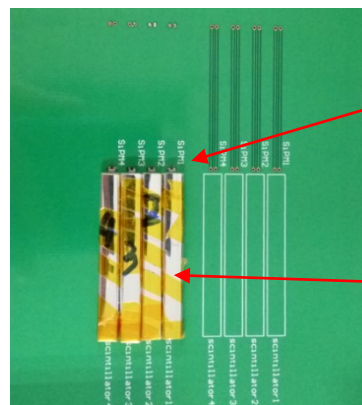
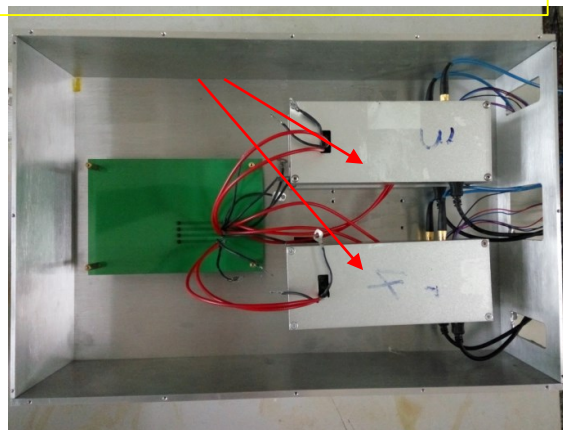
**BGO**

H\_Channel\_7.Chargers



# ECAL: Scintillator Option – Beam Test

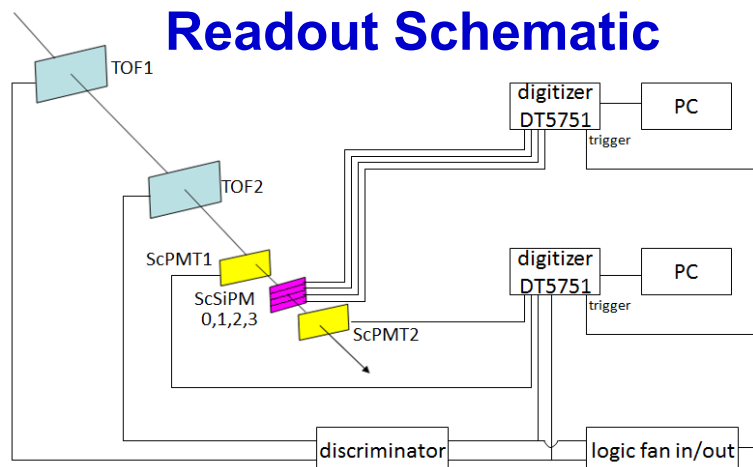
Driver circuit: C12332-01



S12571-025P (Hamamatsu)

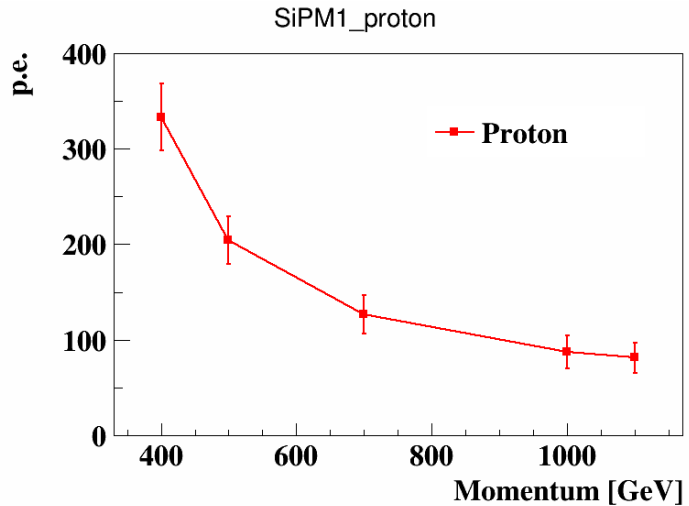
BC408 with dimension of 45mm × 5mm × 2mm

## Readout Schematic

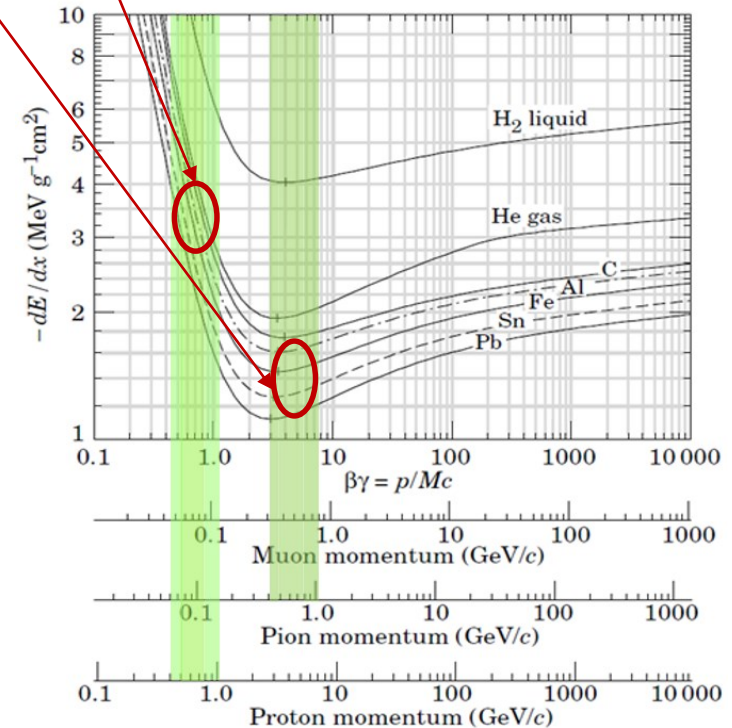
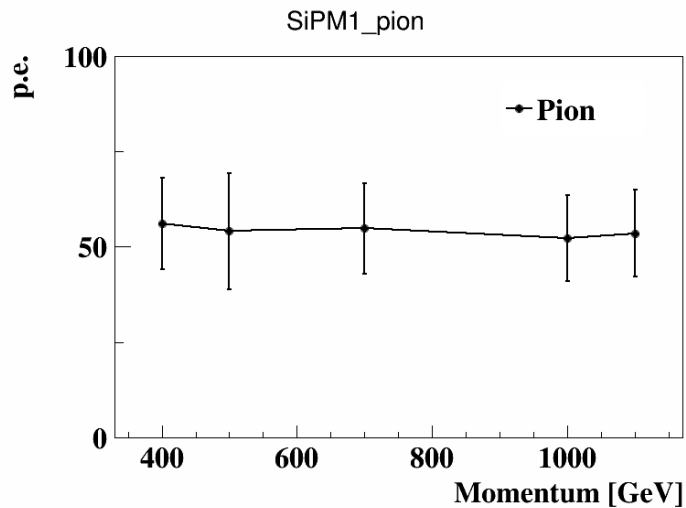


- Mini prototype was constructed and tested by test beam to study layout and coupling mode of the scintillator and SiPM
- Performed at E3 beam at IHEP, proton and pion mixed irradiation, momentum of the particles range from 400MeV to 1.1GeV

# ECAL: Scintillator Option – Energy deposition and momentum



Momentum (MeV/c)	400	500	700	1000	1100
$\beta\gamma(\text{proton})$	0.43	0.53	0.75	1.07	1.17
$\beta\gamma(\text{pion})$	2.87	3.59	5.02	7.17	7.89



- $dE/dx$  (proton and pion) consistent with expectation

# Summary and Outlook

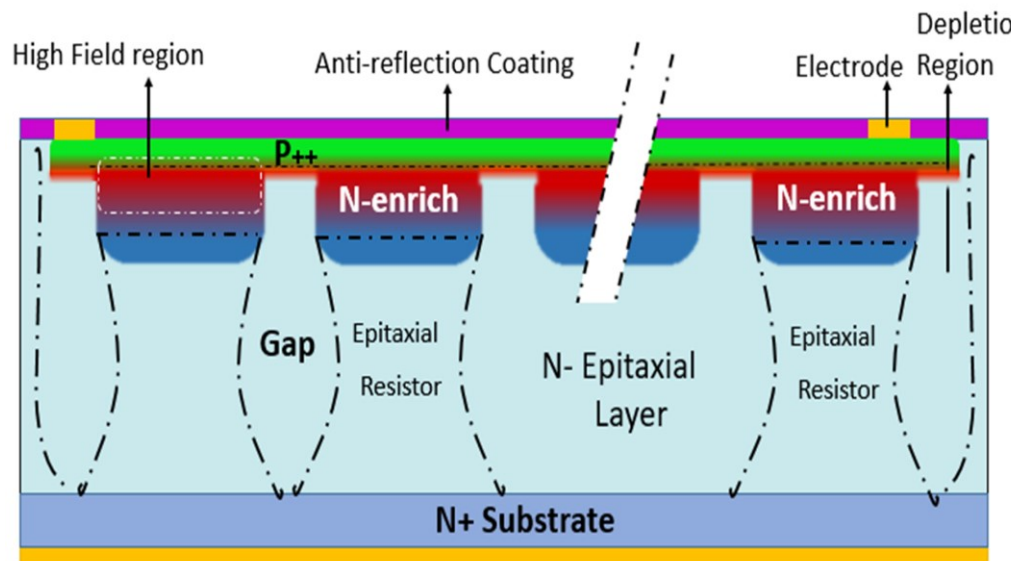
- ✓ **CEPC calorimeter R&D well underway**
  - ✓ HCAL & ECAL
  - ✓ Aiming for PFA calorimeter with high granularity
- ✓ **Lots of R&D to be done**
  - ✓ Build a sizable HCAL/ECAL prototype
  - ✓ Beam test
  - ✓ Other critical R&D items
- ✓ **Welcome worldwide collaboration**
  - ✓ Close collaboration with IPNL already fruitful
  - ✓ Joined efforts within CALICE collaboration
  - ✓ Become more integrated into global PFA calorimeter R&D activities in the future



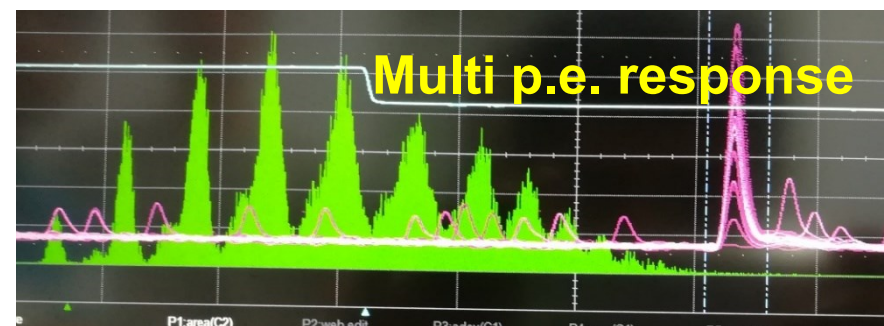
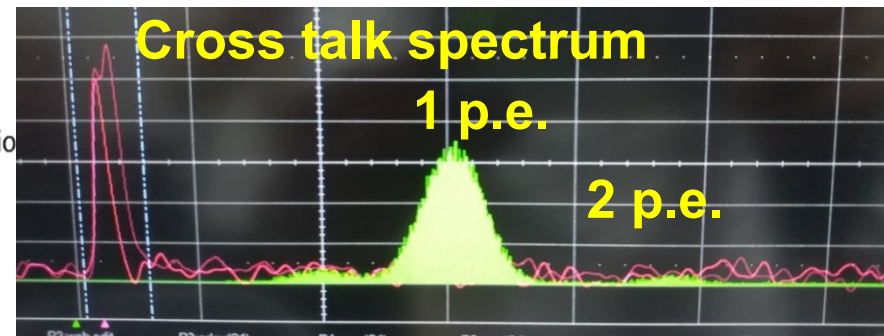
# Backup

# Chinese NDL SiPM

- Chinese Beijing Normal University (BNU) has developed silicon photomultiplier (SiPM) technology with epitaxial quenching resistors (EQR).
- NDL EQR-SiPM is easy to implement owing to its unique structure featuring intrinsic continuous and uniform cap resistor layer, hence reducing the cost of the fabrication.



**Schematic structure of EQR SiPM**



# Parameters and performance of NDL SiPM

	NDL SiPM	
	11-3030 B-S	22-1414 B-S
Effective Active Area	3.0×3.0 mm <sup>2</sup>	1.4×1.4 mm <sup>2</sup> (2×2 Array)
Effective Pitch	10 μm	10 μm
Micro-cell Number	90000	19600
Fill Factor	40%	40%
Breakdown Voltage (V <sub>b</sub> )	23.7 ± 0.1V	23.7 ± 0.1V
Measurement Overvoltage (V)	3.3	3.3
Peak PDE	27% @ 420nm	35% @ 420nm
Max. Dark Count (kcps)	< 7000	< 1500
Gain	2×10 <sup>5</sup>	2×10 <sup>5</sup>
Temp. Coef. For V <sub>b</sub>	17mV/° C	17mV/° C

Good performance,  
Room for improvement

Higher dynamic range  
Higher fill-factor

High Dark count rate

Slightly low gain